

TC74VHC257FN

Quad 2-Channel Multiplexer (3-state)

The TC74VHC257 is an advanced high speed CMOS MULTIPLEXER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It is composed of four independent 2-channel multiplexers with common $\overline{\text{SELECT}}$ and $\overline{\text{OUTPUT ENABLE}} (\overline{\text{OE}})$.

If $\overline{\text{OE}}$ is set low, the outputs are held in a high-impedance state. When $\overline{\text{SELECT}}$ is set low, "A" data inputs are enabled.

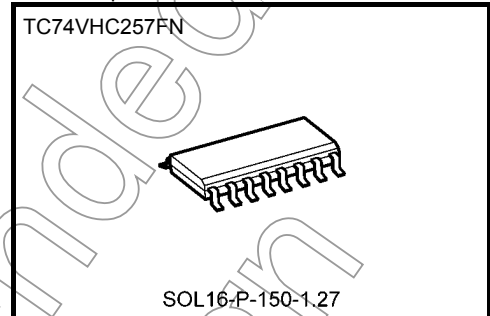
Conversely, when $\overline{\text{SELECT}}$ is high, "B" data inputs are enabled.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

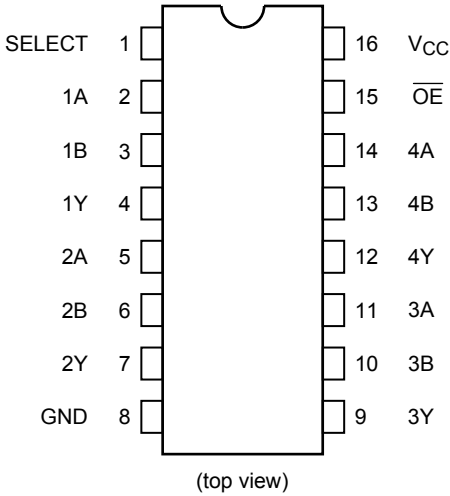
- High speed: $t_{pd} = 3.6 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu\text{A (max)}$ at $T_a = 25^\circ\text{C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (min)}$
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: $V_{CC} \text{ (opr)} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: $V_{OLP} = 0.8 \text{ V (max)}$
- Pin and function compatible with 74ALS257

Note: xxxFN (JEDEC SOP) is not available in Japan.

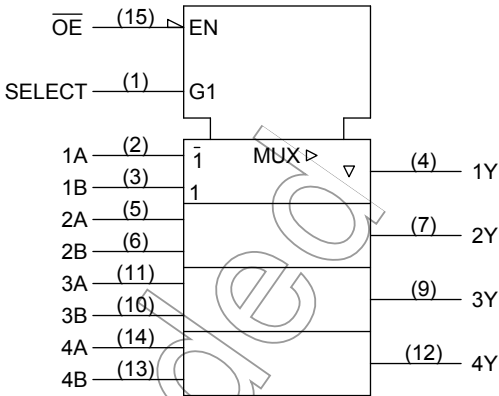


Weight
SOL16-P-150-1.27 : 0.13 g (typ.)

Pin Assignment



IEC Logic Symbol



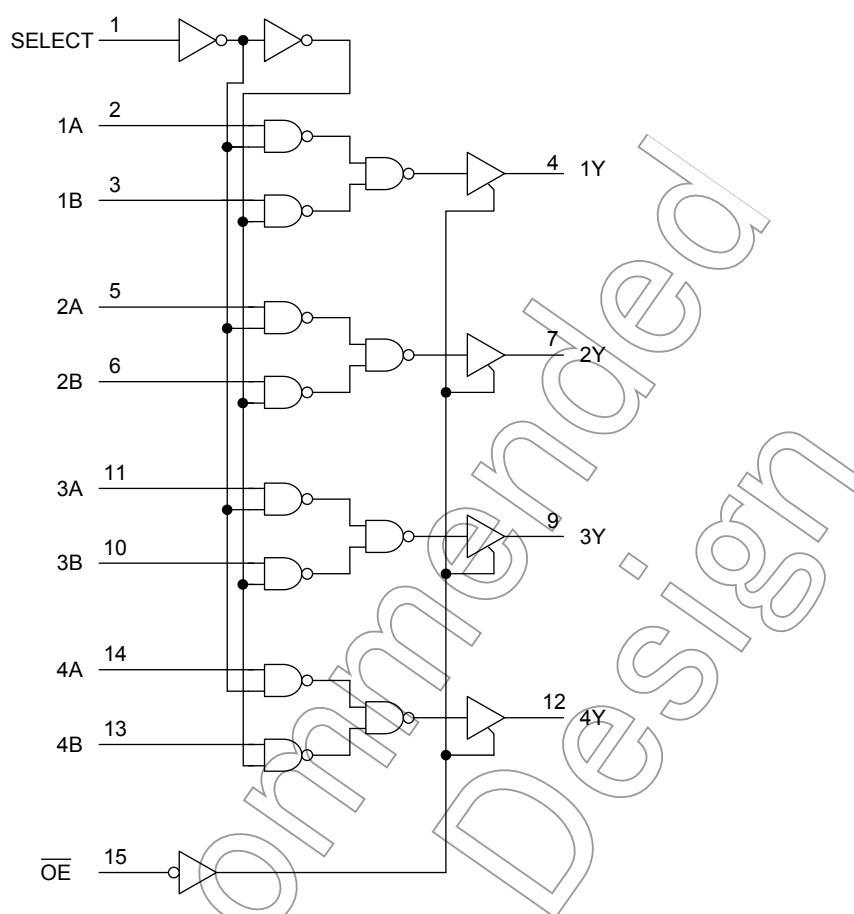
Truth Table

Inputs				Output
OE	SELECT	A	B	
H	X	X	X	Z
L	L	L	X	L
L	L	H	X	H
L	H	X	L	L
L	H	X	H	H

X: Don't care

Z: High impedance

System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5 to 7.0	V
DC input voltage	V_{IN}	-0.5 to 7.0	V
DC output voltage	V_{OUT}	-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}	-20	mA
Output diode current	I_{OK}	± 20	mA
DC output current	I_{OUT}	± 25	mA
DC V_{CC} /ground current	I_{CC}	± 50	mA
Power dissipation	P_D	180	mW
Storage temperature	T_{stg}	-65 to 150	$^{\circ}\text{C}$

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 5.5	V
Input voltage	V_{IN}	0 to 5.5	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 ($V_{CC} = 3.3 \pm 0.3$ V) 0 to 20 ($V_{CC} = 5 \pm 0.5$ V)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
				VCC (V)	Min	Typ.	Max	Min		Max
High-level input voltage	VIH	—		2.0 3.0 to 5.5	1.50 VCC × 0.7	— —	— —	1.50 VCC × 0.7	— —	V
Low-level input voltage	VIL	—		2.0 3.0 to 5.5	— —	— —	0.50 VCC × 0.3	— —	0.50 VCC × 0.3	V
High-level output voltage	VOH	VIN = VIH or VIL	I _{OH} = -50 μA	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	— — —	1.9 2.9 4.4	— — —	V
			I _{OH} = -4 mA	3.0	2.58	—	—	2.48	—	
			I _{OH} = -8 mA	4.5	3.94	—	—	3.80	—	
Low-level output voltage	VOL	VIN = VIH or VIL	I _{OL} = 50 μA	2.0 3.0 4.5	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	0.1 0.1 0.1	V
			I _{OL} = 4 mA	3.0	—	—	0.36	—	0.44	
			I _{OL} = 8 mA	4.5	—	—	0.36	—	0.44	
3-state output off-state current	IOZ	VIN = VIH or VIL VOUT = VCC or GND		5.5	—	—	±0.25	—	±2.50	μA
Input leakage current	IIN	VIN = 5.5 V or GND		0 to 5.5	—	—	±0.1	—	±1.0	μA
Quiescent supply current	ICC	VIN = VCC or GND		5.5	—	—	4.0	—	40.0	μA

AC Characteristics (input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
			V _{CC} (V)	C _L (pF)	Min	Typ.	Max	Min	Max	
Propagation delay time (A, B-Y)	t_{pLH} t_{pHL}	—	3.3 ± 0.3	15	—	5.8	9.3	1.0	11.0	ns
				50	—	8.3	12.8	1.0	14.5	
			5.0 ± 0.5	15	—	3.6	5.9	1.0	7.0	
				50	—	5.1	7.9	1.0	9.0	
Propagation delay time (SELECT-Y)	t_{pLH} t_{pHL}	—	3.3 ± 0.3	15	—	7.0	11.0	1.0	13.0	ns
				50	—	9.5	14.5	1.0	16.5	
			5.0 ± 0.5	15	—	4.0	6.8	1.0	8.0	
				50	—	5.5	8.8	1.0	10.0	
3-state output enable time	t_{pZL} t_{pZH}	$R_L = 1\text{ k}\Omega$	3.3 ± 0.3	15	—	6.7	10.5	1.0	12.5	ns
				50	—	9.2	14.0	1.0	16.0	
			5.0 ± 0.5	15	—	3.6	6.8	1.0	8.0	
				50	—	5.1	8.8	1.0	10.0	
3-state output disable time	t_{pLZ} t_{pHZ}	$R_L = 1\text{ k}\Omega$	3.3 ± 0.3	50	—	8.6	12.0	1.0	13.5	ns
			5.0 ± 0.5	50	—	5.7	7.9	1.0	9.0	
Input capacitance	C _{IN}	—	—	—	—	4	10	—	10	pF
Output capacitance	C _{OUT}	—	—	—	—	6	—	—	—	pF
Power dissipation capacitance	C _{PD}	—	—	(Note)	—	23	—	—	—	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

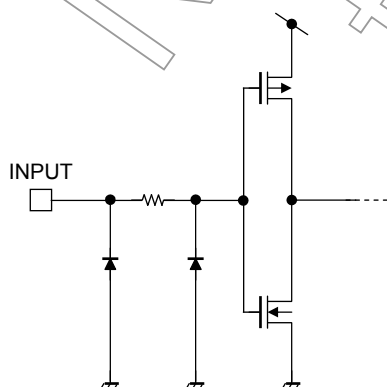
Average operating current can be obtained by the equation:

$$I_{CC(\text{opr})} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per bit)}$$

Noise Characteristics (input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Test Condition		Ta = 25°C		Unit
			V _{CC} (V)	Typ.	Max	
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.3	-0.8	V
Minimum high level dynamic input voltage	V _{IHD}	C _L = 50 pF	5.0	—	3.5	V
Maximum low level dynamic input voltage	V _{ILD}	C _L = 50 pF	5.0	—	1.5	V

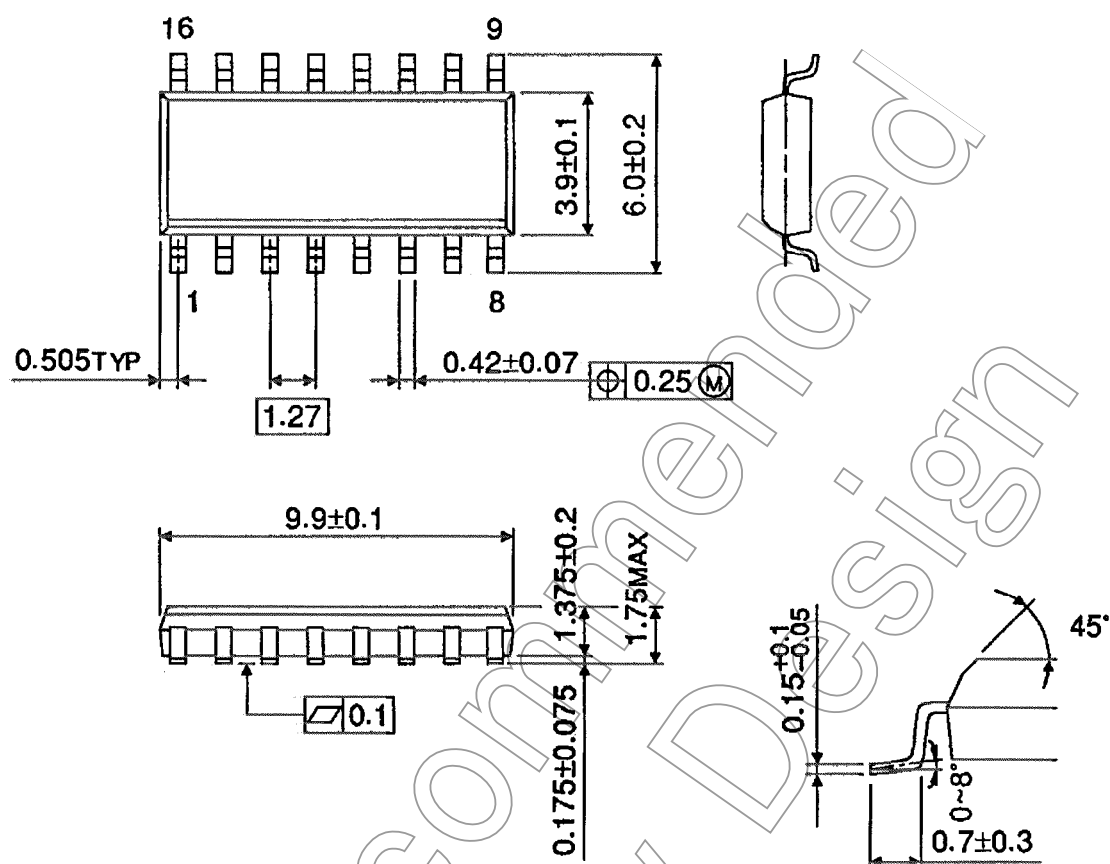
Input Equivalent Circuit



Package Dimensions (Note)

SOL16-P-150-1.27

Unit : mm



Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

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